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#### **DATA SHEET**

# SKY13575-639LF: Dual-Band Matched SP4T WiFi Switch

#### **Applications**

- Dual-band WLAN
- 3G/4G LTE systems
- WLAN 802.11a/b/g/n/ac

#### **Features**

- $\bullet$  Off ports matched to 50  $\Omega$
- Low insertion loss: 0.6 dB at 2.5 GHz, 1.1 dB at 6 GHz (typical)
- High isolation: 40 dB at 2.5 GHz, 30 dB at 6 GHz (typical)
- Integrated GPIO interface
- Small QFN (14-pin, 1.6  $\times$  1.6  $\times$  0.45 mm) package (MSL1, 260 °C per JEDEC J-STD-020)



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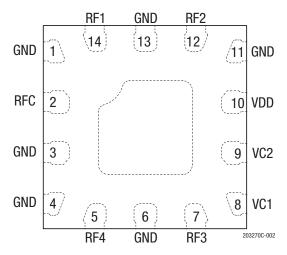


Figure 2. SKY13575-639LF Pinout (Top View)

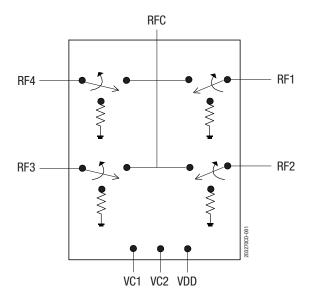


Figure 1. SKY13575-639LF Block Diagram

#### **Description**

The SKY13575-639LF is a dual-band single-pole, four-throw switch with an integrated 50  $\Omega$  match on all RF output ports. External DC blocking capacitors are required on the RF paths. The switch can operate over the temperature range of  $-40^{\circ}\text{C}$  to 90 °C.

Switching is controlled by two CMOS/TTL compatible control voltage inputs: VC1 and VC2. Depending upon the logic voltage level applied to the control pins, the RFC pin is connected to one of four switched RF outputs (RF1 to RF4) by a low insertion loss path, while the path between the RFC pin and the other RF pins is in isolation. The isolated ports are terminated to a 50  $\Omega$  load.

The SKY13575-639LF is packaged in a small, 14-pin,  $1.6 \times 1.6 \times 0.45$  mm QFN package.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional descriptions are provided in Table 1.

Table 1. SKY13575-639LF Pin Descriptions<sup>1</sup>

| Pin | Name | Description      | Pin | Name | Description       |
|-----|------|------------------|-----|------|-------------------|
| 1   | GND  | Ground           | 8   | VC1  | Control voltage 1 |
| 2   | RFC  | RF common port   | 9   | VC2  | Control voltage 2 |
| 3   | GND  | Ground           | 10  | VDD  | Battery voltage   |
| 4   | GND  | Ground           | 11  | GND  | Ground            |
| 5   | RF4  | RF output port 4 | 12  | RF2  | RF output port 2  |
| 6   | GND  | Ground           | 13  | GND  | Ground            |
| 7   | RF3  | RF output port 3 | 14  | RF1  | RF output port 1  |

<sup>&</sup>lt;sup>1</sup> Exposed pads must be grounded

## **Electrical and Mechanical Specifications**

The absolute maximum ratings of the SKY13575-639LF are provided in Table 2. Electrical specifications are provided in Table 3. The SKY13575-639LF logic truth is shown in Table 4.

Table 2. SKY13575-639LF Absolute Maximum Ratings<sup>1</sup>

| Parameter                              | Symbol    | Condition                                                  | Minimum | Maximum | Units |
|----------------------------------------|-----------|------------------------------------------------------------|---------|---------|-------|
| Supply voltage                         | VDD       | T = 25 °C                                                  |         | 3.7     | V     |
| Control voltage                        | Vc1, Vc2  | T = 25 °C                                                  | -0.5    | 3.3     | V     |
| RF input power                         | RFIN      | Peak power at RFC port, T = 25 °C; 50 $\Omega$             |         | +32     | dBm   |
| Output port 50 $\Omega$ power handling | 50 Ω PMAX | Maximum power applied to the output port in isolation mode |         | +5      | dBm   |
| Operating case temperature             | TCASEMAX  |                                                            | -40     | +90     | °C    |
| Storage temperature                    | TSTORE    |                                                            | -55     | +150    | °C    |

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**CAUTION**: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SKY13575-639LF Electrical Specifications<sup>1</sup> (VDD = 3.3 V, VC1 = VC2 = High = 3.0 V, PIN = 0 dBm, TOP = +25 °C, Characteristic Impedance [ZO] = 50  $\Omega$ , Unless Otherwise Noted)

| Parameter                                               | Symbol       | Test Condition                                              | Minimum        | Typical           | Maximum           | Units          |
|---------------------------------------------------------|--------------|-------------------------------------------------------------|----------------|-------------------|-------------------|----------------|
| Small Signal                                            | •            |                                                             | <u> </u>       |                   | •                 |                |
| Insertion loss (RFC to RF1,2,3,4)                       | IL           | 0.1 to 2.4 GHz<br>2.4 to 2.5 GHz<br>4.8 to 6.0 GHz          |                | 0.6<br>0.6<br>1.1 | 0.8<br>0.9<br>1.4 | dB<br>dB<br>dB |
| Isolation (RFC to RF1,2,3,4)                            | Iso          | 0.1 to 2.4 GHz<br>2.4 to 2.5 GHz<br>4.8 to 6.0 GHz          | 35<br>35<br>26 | 40<br>40<br>30    |                   | dB<br>dB<br>dB |
| Output return loss in isolation state (RF1,2,3,4)       | RL_Off Port  | 2.4 to 2.5 GHz<br>4.8 to 6.0 GHz                            | 14             | 17<br>10.5        |                   | dB<br>dB       |
| Large Signal                                            |              |                                                             |                |                   |                   |                |
| LB 2nd harmonics (RFC to RF1,2,3,4)                     | 2fo          | fo = 2.4 to 2.5 GHz<br>PIN = + 20 dBm                       | 65             | 80                |                   | dBc            |
| LB 3nd harmonics (RFC to RF1,2,3,4)                     | 3fo          | fo = 2.4 to 2.5 GHz<br>PIN = + 20 dBm                       | 70             | 80                |                   | dBc            |
| HB 2nd harmonics (RFC to RF1,2,3,4)                     | 2fo          | fo = 4.8 to 6.0 GHz<br>PIN = + 20 dBm                       | 52             | 70                |                   | dBc            |
| HB 3nd harmonics (RFC to RF1,2,3,4)                     | 3fo          | fo = 4.8 to 6.0 GHz<br>PIN = + 20 dBm                       | 60             | 70                |                   | dBc            |
| LB EVM power (RFC to RF1,2,3,4)                         | P_EVM_LB     | fo = 2.45 GHz, input power for 2.5% error, 802.11g, 54 Mbps | 25             | 27                |                   | dBm            |
| HB EVM power (RFC to RF1,2,3,4)                         | P_EVM_HB     | fo = 5.8 GHz, input power for 2.5% error, 802.11g, 54 Mbps  | 25             | 27                |                   | dBm            |
| LB input IP3 (RFC to RF1,2,3,4),<br>+20 dBm input power | LB_IIP3      | Two tones, 1 MHz spacing, fo = 2.4 to 2.5 GHz               | +52            | +55               |                   | dBm            |
| HB Input IP3 (RFC to RF1,2,3,4),<br>+20 dBm input power | HB_IIP3      | Two tones, 1 MHz spacing fo = 4.8 to 6.0 GHz                | +52            | +55               |                   | dBm            |
| DC Operating                                            |              |                                                             |                |                   |                   |                |
| Supply voltage                                          | VDD          | T = 25 °C                                                   | 2.5            | 3.3               | 3.5               | ٧              |
| Control voltage high                                    | Vc1_H, Vc2_H | T = 25 °C                                                   | 2.5            | 3.0               | 3.3               | V              |
| Control voltage low                                     | VC1_L, VC2_L | T = 25 °C                                                   |                | 0                 | 0.45              | V              |
| Supply current                                          | IDD          | T = 25 °C                                                   |                | 8                 | 10                | μА             |
| Switching speed                                         | SS           | 50 % CTL to 90 % RF<br>50 % CTL to 10 % RF                  |                | 400               | 500               | ns             |
| Rise/fall time                                          | ton/toff     | 10% RF to 90 % RF<br>90 % RF to 10 % RF                     |                |                   | 500               | ns             |
| Startup time                                            | tstart       | From VDD off to VDD on                                      |                | 500               | 1000              | ns             |

<sup>&</sup>lt;sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

Table 4. Logic Truth Table<sup>1</sup>

| Low-Loss Path | VC1 | VC2 |  |
|---------------|-----|-----|--|
| RFC to RF1    | L   | L   |  |
| RFC to RF2    | L   | Н   |  |
| RFC to RF3    | Н   | L   |  |
| RFC to RF4    | Н   | Н   |  |

 $<sup>^{1}</sup>$  H = 2.5 to 3.3 V L = 0 to 0.45 V

#### **Evaluation Board Description**

The SKY13575-639LF Evaluation Board is used to test the performance of the SKY13575-639LF. An Evaluation Board schematic diagram is provided in Figure 3. Figure 4 shows the Evaluation Board assembly diagram.

### **Package Dimensions**

The PCB layout footprint for the SKY13575-639LF is provided in Figure 5. Typical part markings are shown in Figure 6. Package dimensions are shown in Figure 7, and tape and reel dimensions are provided in Figure 8.

#### **Package and Handling Information**

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY13575-639LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

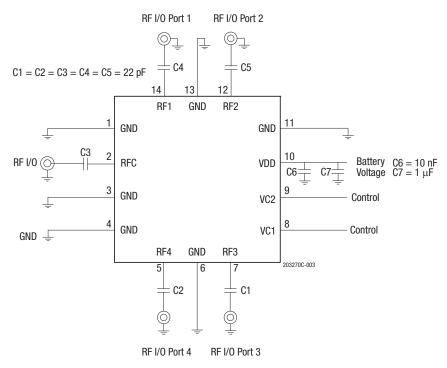


Figure 3. SKY13575-639LF Evaluation Board Schematic

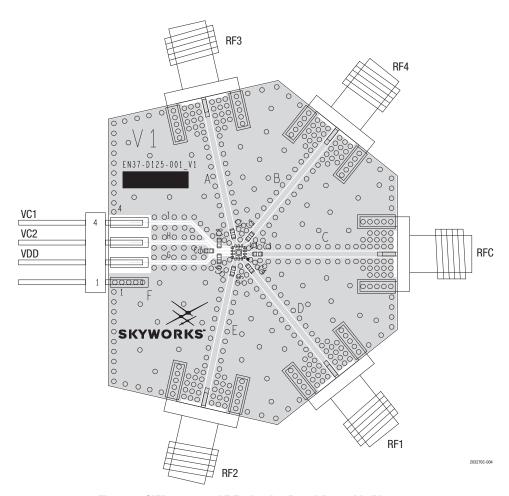
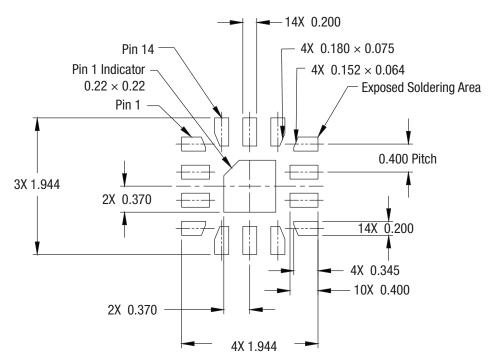


Figure 4. SKY13575-639LF Evaluation Board Assembly Diagram



All dimensions are in millimeters.

203270C-005

Figure 5. SKY13575-639LF PCB Layout Footprint (Bump Side Down)

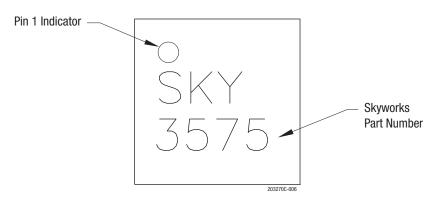
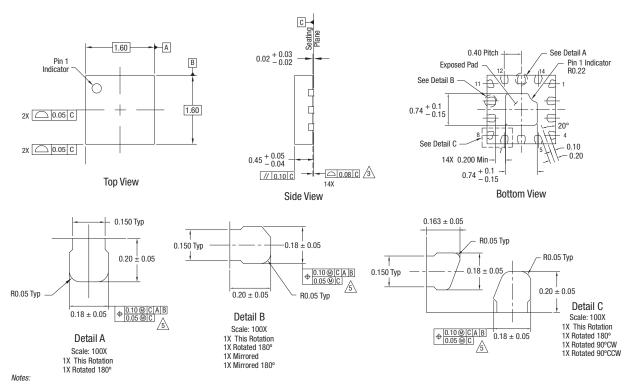


Figure 6. Typical Part Markings (Top View)

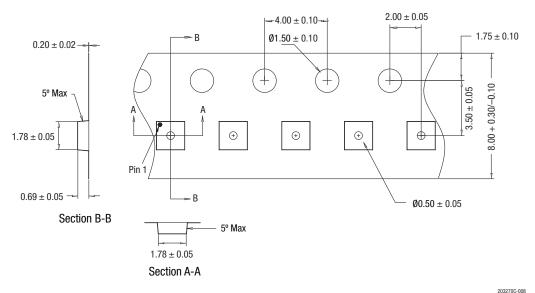


- 1. All dimensions are in millimeters.
- 1. Air uninerisons are in minimeters.
  2. Dimensions and tolerances per ASME Y14.5M-1994.
  3. Coplanarity applies to the terminal and all other bottom surface metallization.

Plating requirements per source control drawing (SCD) 2504.
 Dimension applies to metallized terminal. If the terminal has a radius on its end, the width dimension should not be measured in the radius area.

203270C-007

Figure 7. SKY13575-639LF Package Dimensions



All measurements are in millimeters unless otherwise stated.

Figure 8. SKY13575-639LF Tape and Reel Dimensions

#### **Ordering Information**

| Model Name                       | Manufacturing Part Number | Evaluation Board Part Number |  |
|----------------------------------|---------------------------|------------------------------|--|
| SKY13575-639LF: SP4T WiFi Switch | SKY13575-639LF            | SKY13575-639LF-EVB           |  |

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